## STRESS FREE TEMPERATURE TESTING AND CALCULATIONS ON OUT-OF-AUTOCLAVE COMPOSITES

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## ABSTRACT

Future launch vehicles will require the incorporation of large composite parts that will make up primary and secondary components of the vehicle. NASA has explored the feasibility of manufacturing these large components using Out-of-Autoclave impregnated carbon fiber composite systems through many composites development projects. Most recently, the Composites for Exploration Project has been looking at the development of a 10 meter diameter fairing structure, similar in size to what will be required for a heavy launch vehicle. The development of new material systems requires the investigation of the material properties and the stress in the parts. Residual stress is an important factor to incorporate when modeling the stresses that a part is undergoing. Testing was performed to verify the stress free temperature with two-ply asymmetric panels. A comparison was done between three newly developed out of autoclave IM7/Bismaleimide (BMI) systems. This paper presents the testing results and the analysis performed to determine the stress free temperature of the materials.

## **1. INTRODUCTION**

The Composites for Exploration project was started in order to advance the development of composite systems for large primary structure applications, such as a payload fairing similar in size to what is needed for a heavy lift vehicle like the Space Launch System. The goal was to demonstrate mass savings and cost savings over metal structures, while reducing the risk for use of composite structures on future NASA vehicles. A graphite/bismaleimide (BMI) system was chosen because of its high operating temperature, which reduces the amount of thermal protection needed, further decreasing the weight. Due to the size of the payload fairing, and in order to minimize the number of joints, the composite must be cured out of the autoclave. This led NASA to request an Out-of-Autoclave (OOA) composite system be developed that could be cured at 177°C. Three manufacturers provided materials, which are undergoing testing by NASA. Kennedy Space Center has been performing stress free temperature testing, which will be used for residual stress calculations, in support of this effort.

#### **1.1 Residual Stress**

Carbon fiber reinforced composites have residual stresses due to the coefficient of thermal expansion (CTE) mismatch between the carbon fiber and the resin matrix. Several studies have investigated the residual stress and stress free temperature of polymer matrix composites [1-5].

As the material is cured, it develops an equilibrium state at the elevated temperature. As the material cools, stresses develop within the part. In order to better understand the mechanical behavior of this material, especially for use as a primary structure, it is important to understand how much stress is in the material under no external loading. McGinnis, et al, [6] give a residual stress equation for a two layer system (layers A and B):

$$\sigma_A = \frac{1}{d_A} \left( \frac{(\alpha_B - \alpha_A)\Delta T}{\frac{1 - \nu_A}{d_A E_A} + \frac{1 - \nu_B}{d_B E_B}} \right)$$

(1)

Where

d = layer thickness

 $\alpha$  = Coefficient of thermal expansion

$$\Delta T = T_{SF} - T$$

 $T_{SF} = Stress$  Free Temperature

T = Current Temperature

v = Poisson's ratio

E = Young's Modulus

This equation shows a direct proportional relationship between the residual stress and  $\Delta T$ . Therefore, the higher the stress free temperature, the higher the residual stress. If the highest loading environment of the composite part occurs at an elevated temperature,  $\Delta T$  is reduced and thus, the residual stress in the part will be reduced.

Although the stress free temperature should theoretically be the cure temperature, it is still important to verify this value. There are two ways to determine the stress free temperature. A study performed by Sandhu, et al, fabricated two ply asymmetric panels with the configuration [0/90] and then used Timoshenko's analysis of bimetal thermostats, which uses the following equation [7]:

$$\Delta T = \left(\frac{h}{R}\right) \left(\frac{B}{A}\right)$$

(2)

Where

H= thickness of the specimen

R = radius of curvature at the reference temperature

 $A = 24.0(\alpha_0 - \alpha_{90})$ 

$$B = 14.0 + \frac{E_1^t}{E_2^t} + \frac{E_2^t}{E_1^t}$$

 $\alpha_0$  = Coefficient of Thermal Expansion in the fiber direction

 $\alpha_{90}$  = Coefficient of Thermal Expansion in the transverse to the fiber direction

 $E_1^t$  = tensile Young's modulus in fiber direction

 $E_2^t$  = tensile Young's modulus in transverse to fiber direction

By having this unbalanced configuration, the panels are curved at room temperature, giving a visual indication of the stress within the panel (see Figure 1). The radius of the curved panel, along with Young's Modulus and the CTE, are used to find the stress free temperature. Sandhu, et al, explain that this method of obtaining the stress free temperature assumes small displacements and temperature independent elastic properties. [7]

The second way of determining the stress free temperature is to heat the 2 ply asymmetric panel until it is flat. Heating the panel releases these internal stresses and causes the panel to flatten out. When the panel is completely flat, it has reached its stress free temperature. This experimental data can then be compared to the results of Equation 2 above.

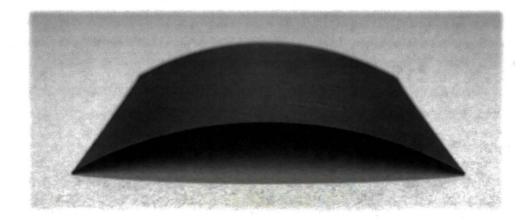


Figure 1. Example of a 2-ply Asymmetric Panel

#### 2. EXPERIMENTATION

#### 2.1 Test Panel Fabrication

BMI/IM7 systems from three different manufacturers were tested: Renegade, Stratton Composites, and Tencate. Two sets of panels were made from each of the three. Table 1 gives the labeling used for the panels. The rows in grey are for panels that were fabricated but have not been tested yet.

Table 1. Test Panel Configuration

	MANUFACTURE				HEATED DEBULK		
PANEL	R	PLIES	SIZE OF PANEL (cm)	LAYUP	TEMP (DEG C)	SET	CONDITION
615-R1	Renegade	2	15.2 X 15.2	[0/90]	40	1	1
615-R2	Renegade	2	15.2 X 15.2	[0/90]	40	1	2
615-S1	Stratton	2	15.2 X 15.2	[0/90]	40	1	1
615-S2	Stratton	2	15.2 X 15.2	[0/90]	40	1	2
615-T1	Tencate	2	15.2 X 15.2	[0/90]	30	1	1
615-T2	Tencate	2	15.2 X 15.2	[0/90]	30	1	2
630-R1	Renegade	2	15.2 X 15.2	[0/90]	60	2	1
630-R2	Renegade	2	15.2 X 15.2	[0/90]	60	2	2
630-S1	Stratton	2	15.2 X 15.2	[0/90]	60	2	1
630-S2	Stratton	2	15.2 X 15.2	[0/90]	60	2	2
630-T1	Tencate	2	15.2 X 15.2	[0/90]	60	2	1
630-T2	Tencate	2	15.2 X 15.2	[0/90]	60	2	2

During panel layup, a heated debulk was conducted prior to placing the panel under vacuum for cure. A heated debulk was used to simulate the heat and pressure used by the Automated Fiber Placement Tool for actual part fabrication. Figure 2 shows the setup for the heated debulk. The panels were debulked for 5 minutes and heated to the temperatures shown in Table 1.

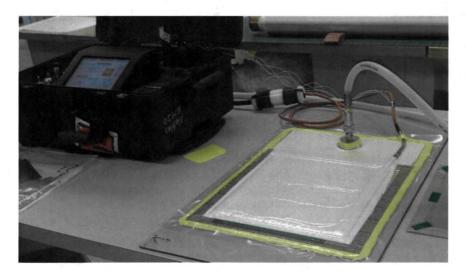


Figure 2: Heat Debulk Setup

Figures 3 and 4 show the cure cycles and the postcure cycles, respectively, based on the recommendations by the manufacturers and the modified cure cycles recommended in the cure study performed by Miller, et al. [8] All panels were cured on a glass plate in a convection oven. After cure, the panels were removed from the vacuum set up and post cured in a free standing condition. Since these panels are curved at room temperature, they were placed in the oven in a concave configuration, as shown in Figure 5. The cure cycles were held to 177°C, but the freestanding postcure ranged from 204°C to 246°C.

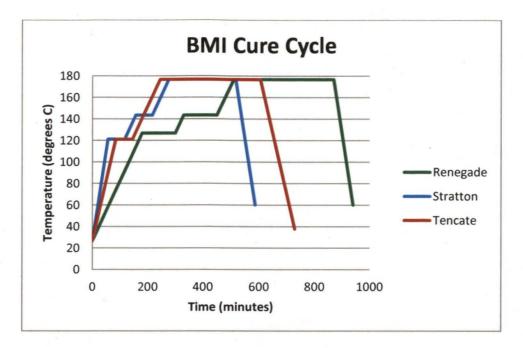


Figure 3: Cure Cycle

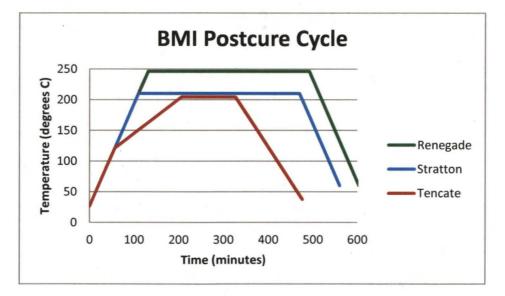


Figure 4: Free Standing Post Cure Cycle



Figure 5: Panels during Post Cure

#### 2.2 Stress Free Temperature Testing

Testing was performed by applying heat to two-ply asymmetric panels. As seen in Sandhu, et al. [7], and Djokic, et al.[9], asymmetric panels are in a curved configuration, as shown in Figure 1 above, which gives a visual and measureable indication of the stresses in the panel. By heating the panel, these stresses are released, which causes the panel to flatten. The temperature where this first occurs is known as the stress free temperature.

Testing was conducted on two-ply asymmetric panels that were fabricated as described in Section 2.1. As shown in Table 1, two conditions were tested. For Condition 1, panels received environmental exposure by being placed in a humidity chamber for 7-10 days prior to testing. The humidity chamber is at 75% RH and 32°C. Weight measurements were taken of small samples, with the same exposure conditions as the panels, both before and after exposure in order to calculate moisture pickup; these values are shown in Table 2. From this, it is evident that Renegade had the highest weight pickup and Tencate had the lowest weight pickup. For Condition 2, which is room temperature dry, panels were placed in a desiccator for at least 24 hours prior to testing, in order to remove the moisture.

Table 2. Weight Measurements Before and After Environmental Exposure

PANEL	Pre Exposure	Post Exposure	% Weight		
PANEL	Weight (g)	Weight (g)	Gain		
615-R1	No Measurements Taken				
630-R1	92.125	92.970	0.917		
030-11	107.080	108.013	0.871		
615-S1	93.616	94.200	0.624		
012-21	98.089	98.754	0.678		
630-S1	87.026	87.597	0.656		
030-31	111.312	112.017	0.633		
615-T1	95.810	96.221	0.429		
012-11	89.101	89.512	0.461		
630-T1	107.074	107.605	0.496		
030-11	90.340	90.783	0.490		

Prior to testing, the radius of curvature was measured on each end of the panel; these values are given in Table 3. This data shows that the panels with environmental conditioning had a slightly higher radius of curvature than the panels that were dry.

Table 3. Radius of Curvature Prior to Testing	Table 3.	Radius of	Curvature	Prior to	Testing
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PANEL	Radius of Curvature (cm)		
615-R1	26.80	27.86	
630-R1	27.97	26.77	
630-R2	26.42	26.06	
615-S1	28.42	28.27	
630-S2	23.09	22.35	
630-T1	30.81	30.61	
615-T2	27.31	28.98	
630-T2	24.36	23.19	

The experiment was conducted in an air circulating oven. Because these panels are very lightweight, a shield was built in order to prevent the airflow from shifting the panel's position during testing. Figure 6 is an example of the configuration of the panel in the oven. Thermocouples were used on the panel itself as well as the piece of glass that the panel was sitting on, and reflective tape was attached to the front edge of both the test panel and the glass, which can be seen in Figure 7. A laser extensometer was used to measure the distance between the pieces of reflective tape that were attached to the top of the curve and the glass plate. Data

acquisition was performed by a Hi-Techniques Synergy P unit at two samples per second. Figure 8 shows the complete setup during testing.

The temperature was ramped up at 2.8° C per minute. Once the panel reached a flat state, the temperature was ramped down to room temperature.



Figure 6: Test Set Up

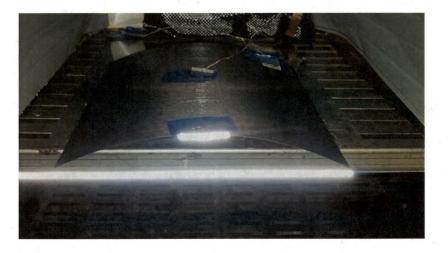


Figure 7: Testing Configuration with Thermocouples and Reflective Tape



Figure 8: Test Setup with Laser Extensometer

# 3. RESULTS

Figure 9 gives a graphical representation of the raw data for one of the panels. The temperature lines are the thermocouple data during the ramp up and ramp down of the oven. The height line shows the distance between the reflective tape on the glass plate and the top of the curve on the panel. The dip in the height data around 5000 seconds is due to slight movement of the laser by the operator in order to more accurately line up with the reflective tape; this slight movement caused erratic data and those values are not indicative of the actual movement of the panel during testing.

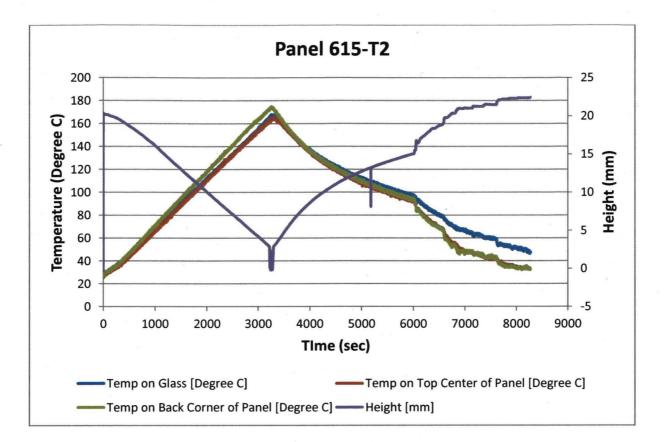


Figure 9: Graph of Data for Panel 615T2

The point where the panel first flattens corresponds to the stress free temperature. Table 4 gives these values based on the temperature data from the two thermocouples located on the panel. Values are given for both the ramp up and the ramp down, except for Panel 615-R2 where data recording was terminated prior to the rampdown. Also, for Panel 615-R2, the thermocouple on the glass was giving inaccurate temperature data so there is no value recorded.

Table 4: Stress Free Temperature Data

PANEL NUMBER	PANEL DESCRIPTION				AVERAGE TEMP ON PANEL (degree C)	
615-R1	Renegade	Set 1	Environmental	Ramp Up	206.44	
	Renegade	Set 1	Environmental	Ramp Down	209.89	
630-R1	Renegade	Set 2	Environmental	Ramp Up	191.06	
	Renegade	Set 2	Environmental	Ramp Down	194.31	
615-R2	Renegade	Set 1	Room Temp, Dry	Ramp Up	169.33	
630-R2	Renegade	Set 2	Room Temp, Dry	Ramp Up	196.50	
	Renegade	Set 2	Room Temp, Dry	Ramp Down	198.72	
	Stratton	Set 1	Environmental	Ramp Up	169.72	
615-S1	Stratton	Set 1	Environmental	Ramp Down	174.72	
	Stratton	Set 1	Room Temp, Dry	Ramp Up	179.58	
615-S2	Stratton	Set 1	Room Temp, Dry	Ramp Down	185.25	
600 FF	Stratton	Set 2	Room Temp, Dry	Ramp Up	183.25	
630-S2	Stratton	Set 2	Room Temp, Dry	Ramp Down	193.06	
615-T1	Tencate	Set 1	Environmental	Ramp Up	154.17	
	Tencate	Set 1	Environmental	Ramp Down	162.44	
630-T1	Tencate	Set 2	Environmental	Ramp Up	127.03	
	Tencate	Set 2	Environmental	Ramp Down	182.75	
615-T2	Tencate	Set 1	Room Temp, Dry	Ramp Up	166.47	
	Tencate	Set 1	Room Temp, Dry	Ramp Down	168.61	

Figure 11 shows the average stress free temperatures taken from the top center of the panel and the back corner of the panel, both during ramp up and ramp down. The first four bars in each set are the temperatures during ramp up and ramp down of the Condition 1 panels. The last four bars in each set are the temperatures during ramp up and ramp down of the Condition 2 panels. From this, we can see that Tencate has the lowest average stress free temperature.

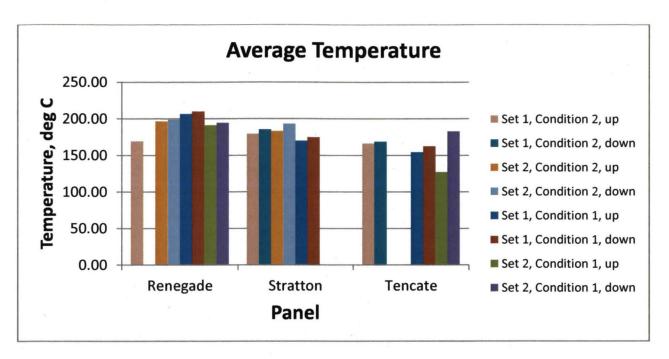
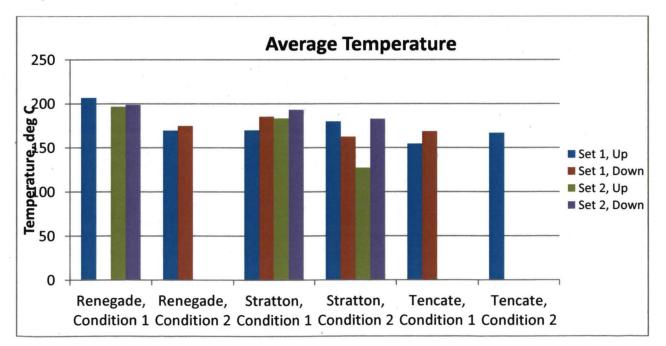


Figure 11: Stress Free Temperature Graph

Figure 12 shows the average stress free temperatures taken from the top center of the panel and the back corner of the panel, both during ramp up and ramp down. The Renegade panels that had environmental exposure (Condition 1) show an increase in stress free temperature. The Stratton panels with environmental exposure have a decrease in the stress free temperature. The Tencate panels with environmental exposure also have a slight decrease, although there is a largest difference between the ramp up stress free temperature and the ramp down stress free temperature for Set 2.



#### Figure 12: Graph of Stress Free Temperatures

The stress free temperature for the Tencate is just below the cure temperature of 177°F, while the stress free temperatures for the Renegade and Stratton are above the cure temperature. The cure study by Miller, et al., on these three BMI systems concluded that the Tencate has a higher degree of cure than the Renegade or the Stratton. A correlation of the degree of cure to the stress free temperature shows that the stress free temperature is closely related to the cure temperature. A higher cure temperature, which would increase the degree of cure for the Stratton and Renegade, would more closely match the stress free temperatures from this test data.

## 4. CONCLUSIONS

Stress free temperatures were determined through testing of asymmetric panels by heating the panels until they flatten, indicating a stress free configuration. Although there is a limited amount of test data so far, Tencate has a consistently lower stress free temperature than Renegade and Stratton. In addition to completing the testing on the panels that have been fabricated, more testing should be done at these conditions in order to increase the sample size. Other variables in addition to environmental exposure may also be considered, such as the effect of the adhesive cured to the composite facesheet of a sandwich panel.

By determining the tensile modulus and the coefficient of thermal expansion, Equation 2 can be used to compare the calculated value to the stress free testing values. The residual stress for each of these systems can then be calculated based on the stress free temperature of the material.

### 5. ACKNOWLEDGEMENTS

The authors would like to thank the Composites for Exploration Project and Dr. Mark Shuart.

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